onsemi

MOSFET – Power, Single N-Channel

60 V, 6.5 mΩ, 70 A

NTTFS5C670NL

Features

- Small Footprint (3.3 x 3.3 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	60	V	
Gate-to-Source Voltage			V _{GS}	±20	V	
Continuous Drain	Steady	$T_{C} = 25^{\circ}C$	۱ _D	70	А	
Current R _{θJC} (Notes 1, 2, 3, 4)		T _C = 100°C		49		
Power Dissipation	State	$T_{C} = 25^{\circ}C$	PD	63	W	
$R_{\theta JC}$ (Notes 1, 2, 3)		$T_{C} = 100^{\circ}C$		31		
Continuous Drain		T _A = 25°C	۱ _D	16	А	
Current R _{θJA} (Notes 1 & 3, 4)	Steady	T _A = 100°C		11		
Power Dissipation	State	T _A = 25°C	PD	3.2	W	
R _{θJA} (Notes 1, 3)		T _A = 100°C		1.6		
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	440	А	
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to +175	°C	
Source Current (Body Diode)			۱ _S	68	А	
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 3.6 A)			E _{AS}	166	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 3)	$R_{\theta JC}$	2.4	°C/W
Junction-to-Ambient - Steady State (Note 3)	$R_{\theta JA}$	47	

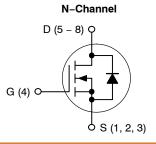
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Psi (Ψ) is used as required per JESD51-12 for packages in which substantially less than 100% of the heat flows to single case surface.

3. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

4. Continuous DC current rating. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

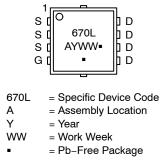
V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
60 V	$6.5~\mathrm{m}\Omega @ 10~\mathrm{V}$	70 A
60 V	9.1 mΩ @ 4.5 V	70 A





(μ8FL) CASE 511AB

MARKING DIAGRAM



(Note: Microdot may be in either location)

ORDERING INFORMATION

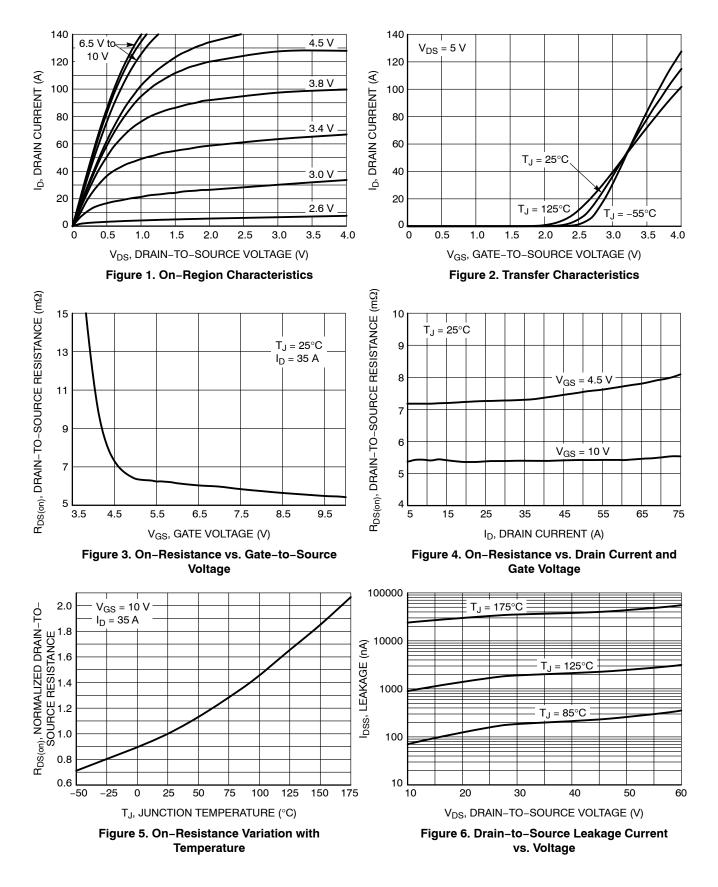
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

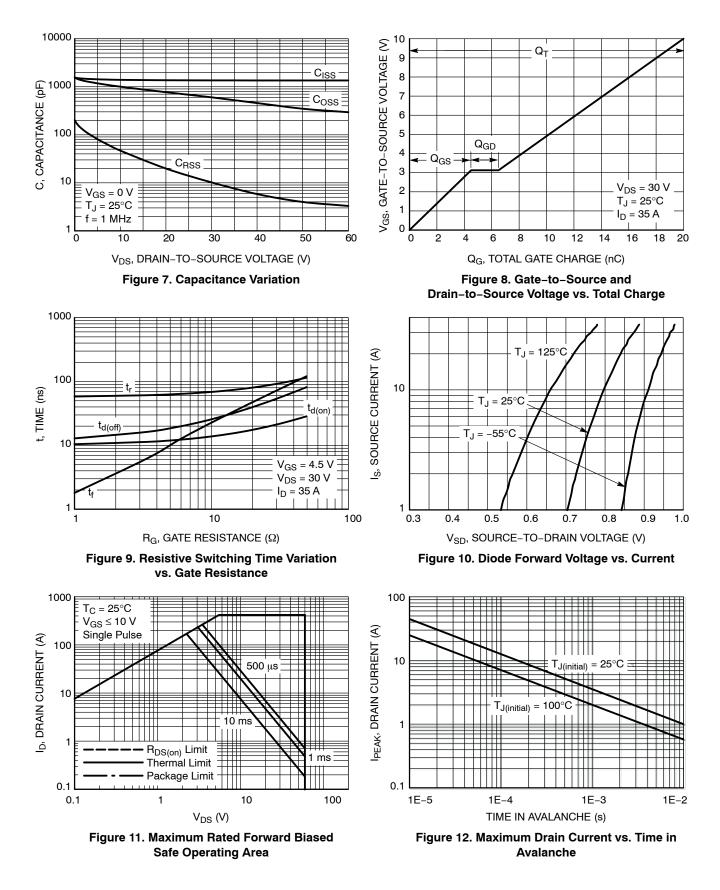
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
OFF CHARACTERISTICS								
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		60			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				27		mV/°C	
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$			10		
		V _{DS} = 60 V	$V_{DS} = 60 \text{ V}$ $T_{J} = 125^{\circ}\text{C}$			250	μΑ	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS} = 20 V$				100	nA	
ON CHARACTERISTICS (Note 5)								
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 50 \ \mu A$		1.2		2.0	V	
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-4.7		mV/°C	
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 35 A		5.4	6.5		
		V _{GS} = 4.5 V	I _D = 35 A		7.3	9.1	mΩ	
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _D = 35 A			82		S	
CHARGES AND CAPACITANCES								
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			1400		pF	
Output Capacitance	C _{OSS}				690			
Reverse Transfer Capacitance	C _{RSS}				15			
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 30 V; I_{D} = 35 A			9.0		nC	
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 30 V; I_{D} = 35 A			20		nC	
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 30 V; I _D = 35 A			2.5		nC V	
Gate-to-Source Charge	Q _{GS}				4.5			
Gate-to-Drain Charge	Q _{GD}				2.0			
Plateau Voltage	V _{GP}				3.1			
SWITCHING CHARACTERISTICS (Note 6)							
Turn–On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V _{DS} = 30 V, I _D = 35 A, R _G = 2.5 Ω			11		ns	
Rise Time	tr				60			
Turn-Off Delay Time	t _{d(OFF)}				15			
Fall Time	t _f				4			
DRAIN-SOURCE DIODE CHARACTERIS	TICS							
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.9	1.2		
		$I_{\rm S} = 35 \rm{A}$	T _J = 125°C		0.8	V		
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, dI _S /d _t = 100 A/µs, I _S = 35 A			34			
Charge Time	ta				17		ns	
Discharge Time	t _b				17		1	
Reverse Recovery Charge	Q _{RR}				19		nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 6. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



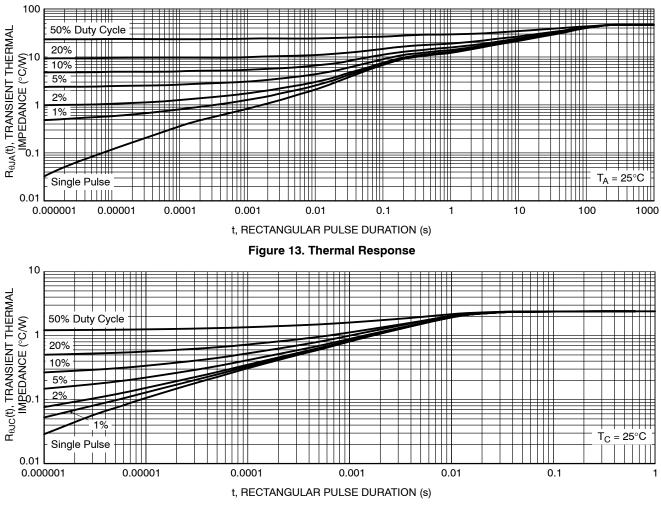


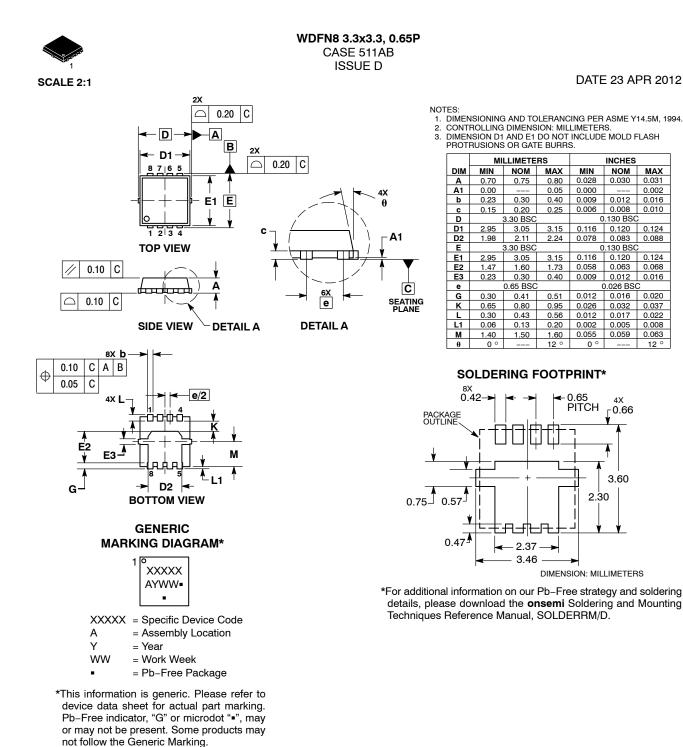
Figure 14. Thermal Response

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTTFS5C670NLTAG	670L	WDFN8 (Pb-Free)	1500 / Tape & Reel
NTTFS5C670NLTWG	670L	WDFN8 (Pb-Free)	5000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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